ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL		UNITS
Drain-source Volt.(1)	VDSS	600	Vdc
Drain-Gate Voltage (R_{GS}=1.0MΩ) (1)	VDGR	600	Vdc
Gate-Source Voltage Continuous	VGS	±20	Vdc
Drain Current Continuous (Tc = 25°C)	ID	20	Adc
Drain Current Pulsed(3)	IDM	80	A
Total Power Dissipation	PD	300	W
Power Dissipation Derating > 25°C		2.4	W/°C
Operating & Storage Temp.	TJ/Tsig	-55 TO +150	°C
Thermal Resistance	RthJc	0.42	°C/W
Max.Lead temperature	TL	300	°C

ELECTRICAL CHARACTERISTICS T_C = 25°C (UNLESS OTHERWISE SPECIFIED)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain-source Breakdown Volt.	V(BR)DSS	VGS=0V ID=250 µA	600	-	-	V
Gate Threshold Voltage	VGS(TH)	VDS=VGS ID=250 µA	2.0	-	4.5	V
Gate Source Leakage	IGSS	VGS=±20 V	-	-	100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=MAX.RATING VGS=0	-	-	250	µA
		VDS=0.8 MAX.RATING VGS=0 TJ=125°C	-	-	1000	µA
Static Drain-Source On-State Resistance(1)	RDS(ON)	VGS=10 V ID=10A	-	-	.35	Ω
Forward Trans-Conductance (2)	gfs	VDS ≥ 50 V IDS=10A	9.0	-	-	S(℧)
Input Capacitance	CISS	VGS=0V VDS=25 V f=1.0 MHz	-	4500	-	pF
Output Capacitance	COSS		-	550	-	pF
Reverse Transfer Capacitance	CRSS		-	160	-	pF
Turn-On Delay	td(on)	VDD=300V Zo=50Ω ID=10A (MOSFET switching times are essentially independent of operating temp.)	-	-	100	ns
Rise Time	tr		-	-	110	ns
Turn-Off Delay	td(off)		-	-	220	ns
Fall Time	tf		-	-	105	ns
Total Gate Charge (Gate-Source Plus Gate-Drain)	Qg	VGS=10V, ID=20A VDS=0.8 MAX.RATING (Gate charge is essentially independent of the operating temperature)	-	165	-	nC
Gate-Source Charge	Qgs		-	65	-	nC
Gate-Drain ("Miller") Charge	Qgd		-	100	-	nC

SOURCE-DRAIN DIODE RATINGS & CHARACT. T_C = 25°C (UNLESS OTHERWISE SPECIFIED)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Continuous Source Current (Body Diode)	IS	Modified MOSFET symbol showing the integral reverse P-N junction rectifier (See schematic)	-	-	20	A
Pulse Source Current (Body Diode) (1)	ISM		-	-	80	A
Diode Forward Voltage (2)	VSD	IF=20A VGS=0V Tc=+25°C	-	-	1.5	V
Reverse Recovery Time	trr	Tc=+25° C IF=20A di/dt=100A/µS	-	500	-	ns
Reverse Recovery Charge	Qrr		-	8.0	-	µC

(1) TJ = 25°C to 150°C.
(2) Pulse test: Pulse Width < 300µS, Duty Cycle < 2%.
(3) Repetitive Rating: Pulse Width limited By Max.junction Temperature.

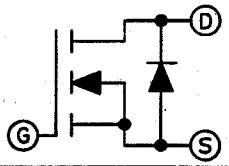
600V, 20A, 0.35Ω

SDF20N60 JEA
SDF20N60 JEB
SDF20N60 JEC
SDF20N60 JED

FEATURES

- RUGGED PACKAGE
- HI-REL CONSTRUCTION
- CERAMIC EYELETS
- LEAD BENDING OPTIONS
- COPPER CORED 52 ALLOY PINS
- LOW IR LOSSES
- LOW THERMAL RESISTANCE
- OPTIONAL MIL-S-19500 SCREENING

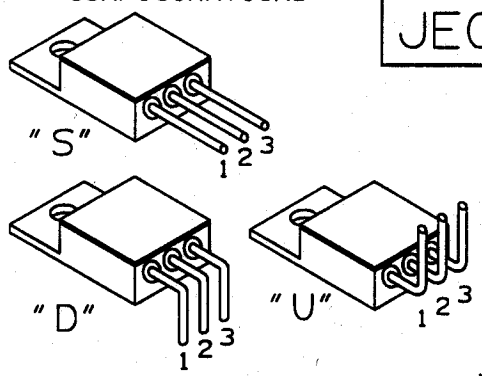
SCHEMATIC



TERMINAL CONNECTIONS			
G		H	
1	GATE	1	DRAIN
2	DRAIN	2	SOURCE
3	SOURCE	3	GATE

JEA JEC

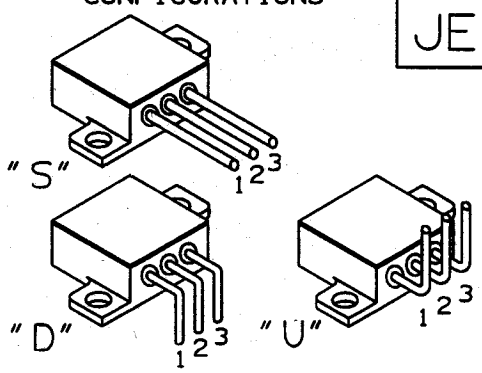
STANDARD BEND CONFIGURATIONS



(CUSTOM BEND OPTIONS AVAILABLE)

JEB JED

STANDARD BEND CONFIGURATIONS



(CUSTOM BEND OPTIONS AVAILABLE)

REL.3/93